

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1.(original) A flexible mold having a groove pattern having a predetermined shape and a predetermined size on a surface thereof, comprising:

a base layer made of a first curable material having a viscosity of 3,000 to 100,000 cps at 10 to 80°C; and

a coating layer made of a second curable material having a viscosity of not greater than 200 cps at 10 to 80°C, and coating a surface of said base layer.

2. (original) A flexible mold as defined in claim 1, wherein said base layer and said coating layer are transparent.

3. (original) A flexible mold as defined in claim 1, wherein said first curable material and said second curable material are a photo-curable material.

4. (original) A flexible mold as defined in claim 1, which further comprises a support layer on the back of said base layer.

5. (original) A flexible mold as defined in claim 4, wherein said support layer is transparent.

6. (original) A flexible mold as defined in claim 1, wherein said groove pattern has a lattice-like pattern constituted by a plurality of groove portions so arranged as to be substantially parallel with one another while crossing one another with predetermined gaps.

7. (original) A method of manufacturing a microstructure having a projection pattern having a predetermined shape and a predetermined size on a surface of a substrate, comprising the steps of:

preparing a flexible mold having a groove pattern having a shape and a size

corresponding to those of said projection pattern on a surface thereof, and including a base layer made of a first curable material having a viscosity of 3,000 to 100,000 cps at 10 to 80°C and a coating layer made of a second curable material having a viscosity of not greater than 200 cps at 10 to 80°C, and coating a surface of said base layer;

arranging a curable molding material between said substrate and said coating layer of said mold and filling said molding material into said groove pattern of said mold;

curing said molding material and forming a microstructure having said substrate and said projection pattern integrally bonded to said substrate; and

releasing said microstructure from said mold.

8. (original) A manufacturing method as defined in claim 7, wherein said molding material is a photo-curable material.

9.(currently amended) A manufacturing method as defined in claim 7[~~-or-8~~], wherein said microstructure is a back plate for a plasma display panel.

10. (original) A manufacturing method as defined in claim 9, which further comprises a step of independently arranging a set of address electrodes substantially in parallel with each other while keeping a predetermined gap between them.